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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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## **700V High and Low Side Driver**

### **Features**

- Drives IGBT/MOSFET power devices
- Gate drive supplies up to 20V per channel
- Undervoltage lockout for  $V_{CC}$  for  $V_{BS}$
- 3.3V, 5V, 15V input logic compatible
- Tolerant to negative transient voltage
- Designed for use with bootstrap power supplies
- Matched propagation delays for all channels
- -40°C to 125°C operating range
- RoHS compliant
- Lead-Free

### **Description**

The IR7106S is a high voltage, high speed, power MOSFET and IGBT gate driver with independent high-side and low-side output channels. This IC is designed to be used with low-cost bootstrap power supplies. Proprietary HVIC and latch immune CMOS technologies have been implemented in a rugged monolithic structure. The floating logic input is compatible with standard CMOS or LSTTL outputs (down to 3.3V logic). The output drivers feature a high-pulse current buffer stage designed for minimum driver cross-conduction. Propagation delays are matched to simplify the HVIC's use in high frequency applications. The floating channel can be used to drive N-channel power MOSFETs or IGBTs in the high-side configuration, which operates up to 700V.

### **Product Summary**

$V_{OFFSET}$	$\leq 700V$
$V_{OUT}$	10V – 20V
$I_{O+}$ & $I_{O-}$ (typ.)	200mA / 350mA
$t_{ON}$ & $t_{OFF}$ (typ.)	220ns & 200ns

### **Package Options**



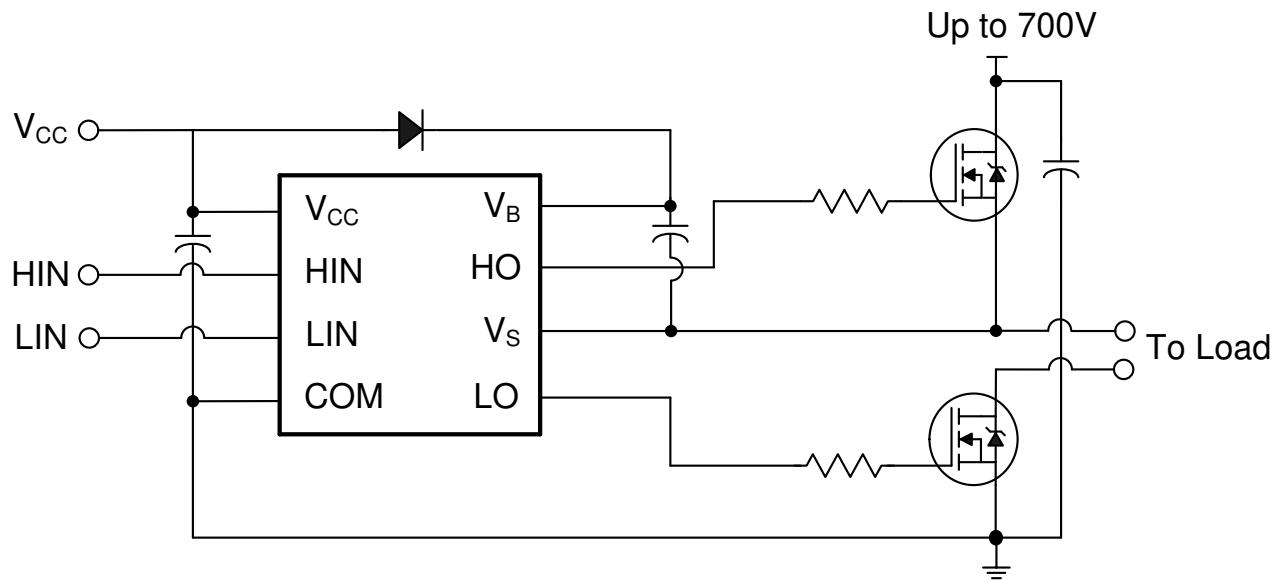
8-Lead SOIC

### **Typical Applications**

- Appliance motor drives
- Servo drives
- Micro inverter drives
- General purpose three phase inverters

<b>Base Part Number</b>	<b>Package Type</b>	<b>Standard Pack</b>		<b>Orderable Part Number</b>
		<b>Form</b>	<b>Quantity</b>	
IR7106SPBF	SO8N	Tube	95	IR7106SPBF
IR7106SPBF	SO8N	Tape and Reel	2500	IR7106STRPBF

## Typical Connection Diagram



(Refer to Lead Assignments for correct pin configuration). This diagram shows electrical connections only. Please refer to our Application Notes & Design Tips for proper circuit board layout.

## Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM unless otherwise stated in the table. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units
$V_{CC}$	Low side supply voltage	-0.3	25 <sup>†</sup>	V
$V_{IN}$	Logic input voltage	COM - 0.3	$V_{CC} + 0.3$	
$V_B$	High-side floating well supply voltage	-0.3	725	
$V_S$	High-side floating well supply return voltage	$V_B - 25$	$V_B + 0.3$	
$V_{HO}$	Floating gate drive output voltage	$V_S - 0.3$	$V_B + 0.3$	
$V_{LO}$	Low-side output voltage	COM - 0.3	$V_{CC} + 0.3$	
COM	Power ground	$V_{CC} - 25$	$V_{CC} + 0.3$	
$dV_S/dt$	Allowable $V_S$ offset supply transient relative to $V_{SS}$	—	50	V/ns
$P_D$	Package power dissipation @ $T_A \leq +25^\circ\text{C}$	—	0.625	W
$R_{th,JA}$	Thermal resistance, junction to ambient	—	200	$^\circ\text{C}/\text{W}$
$T_J$	Junction temperature	—	150	$^\circ\text{C}$
$T_S$	Storage temperature	-55	150	
$T_L$	Lead temperature (soldering, 10 seconds)	—	300	

<sup>†</sup> All supplies are tested at 25V.

## Recommended Operating Conditions

For proper operation, the device should be used within the recommended conditions. All voltage parameters are absolute voltages referenced to COM unless otherwise stated in the table. The offset rating is tested with supplies of  $(V_{CC} - \text{COM}) = (V_B - V_S) = 15\text{V}$ .

Symbol	Definition	Min	Max	Units
$V_{CC}$	Low-side supply voltage	10	20	V
$V_{IN}$	HIN, LIN, & EN input voltage	0	$V_{CC}$	
$V_B$	High-side floating well supply voltage	$V_S + 10$	$V_S + 20$	
$V_S$	High-side floating well supply offset voltage <sup>†</sup>	$\text{COM} - 5^\dagger$	700	
$V_{HO}$	Floating gate drive output voltage	$V_S$	$V_B$	
$V_{LO}$	Low-side output voltage	COM	$V_{CC}$	
COM	Power ground	-5	5	
$T_A$	Ambient temperature	-40	125	$^\circ\text{C}$

<sup>†</sup> Logic operation for  $V_S$  of  $-5\text{ V}$  to  $700\text{V}$ . Logic state held for  $V_S$  of  $-5\text{ V}$  to  $-V_{BS}$ . Please refer to Design Tip DT97-3 for more details.

## Static Electrical Characteristics

$(V_{CC} - COM) = (V_B - V_S) = 15V$ .  $T_A = 25^\circ C$  unless otherwise specified. The  $V_{IN}$  and  $I_{IN}$  parameters are referenced to COM. The  $V_O$  and  $I_O$  parameters are referenced to respective  $V_S$  and COM and are applicable to the respective output leads HO or LO. The  $V_{CCUV}$  parameters are referenced to COM. The  $V_{BSUV}$  parameters are referenced to  $V_S$ .

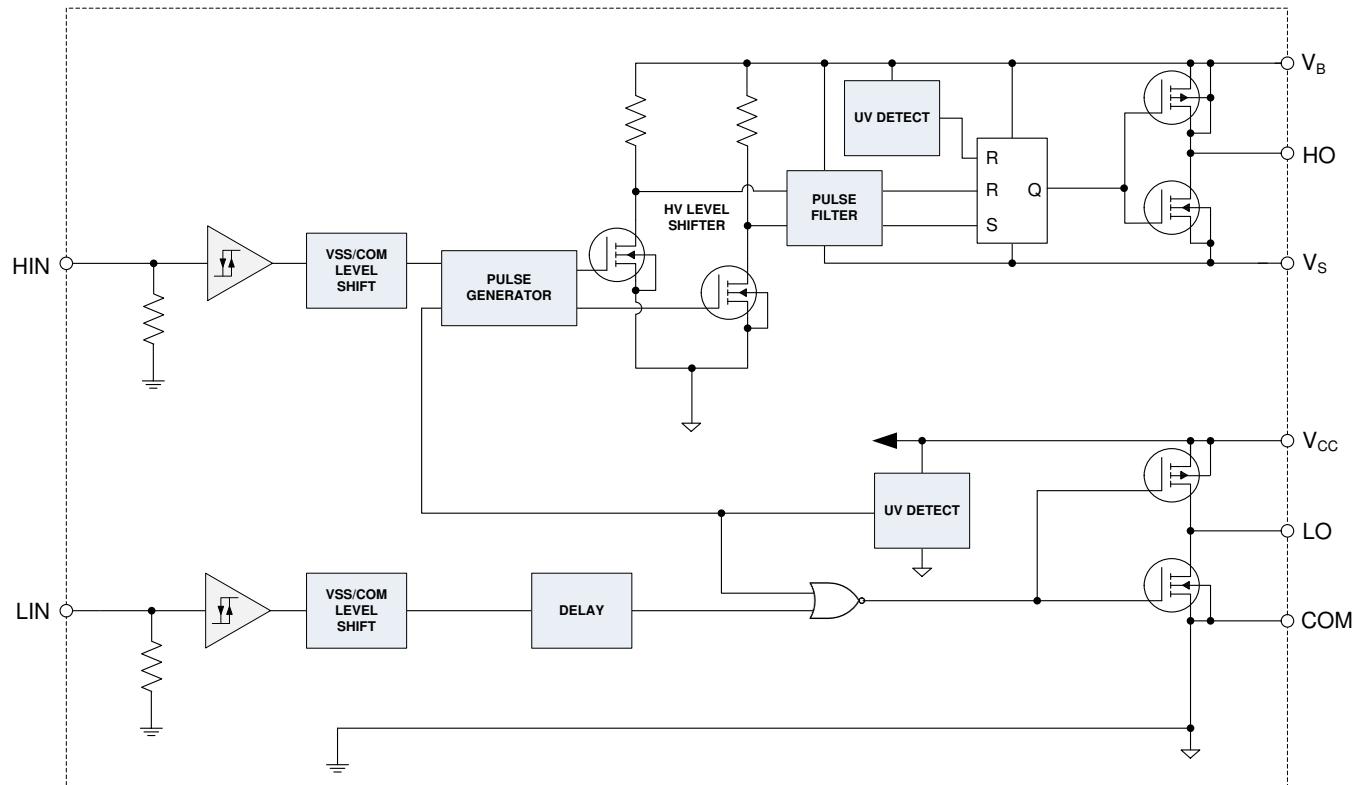
Symbol	Definition	Min.	Typ.	Max.	Units	Test Conditions
$V_{BSUV+}$	$V_{BS}$ supply undervoltage positive going threshold	8	8.9	9.8	V	
$V_{BSUV-}$	$V_{BS}$ supply undervoltage negative going threshold	7.4	8.2	9		
$V_{BSUVHY}$	$V_{BS}$ supply undervoltage hysteresis	0.3	0.7	—		
$V_{CCUV+}$	$V_{CC}$ supply undervoltage positive going threshold	8	8.9	9.8		
$V_{CCUV-}$	$V_{CC}$ supply undervoltage negative going threshold	7.4	8.2	9		
$V_{CCUVHY}$	$V_{CC}$ supply undervoltage hysteresis	0.3	0.7	—		
$I_{LK}$	High-side floating well offset supply leakage	—	—	50	$\mu A$	$V_B = V_S = 700V$
$I_{QBS}$	Quiescent $V_{BS}$ supply current	—	75	130		$V_{IN} = 0V$ or $5V$
$I_{QCC}$	Quiescent $V_{CC}$ supply current	—	120	180		
$V_{OH}$	High level output voltage drop, $V_{BIAS}-V_O$	—	0.80	1.4	V	$I_O = 20mA$
$V_{OL}$	Low level output voltage drop, $V_O$	—	0.30	0.6		
$I_{O+}$	Output high short circuit pulsed current	120	200	—	$mA$	$V_O = 0V$ , $PW \leq 10\mu s$
$I_{O-}$	Output low short circuit pulsed current	250	350	—		$V_O = 15V$ , $PW \leq 10\mu s$
$V_{IH}$	Logic "1" input voltage	2.9	3	—	V	$V_{CC} = 10V$ to $20V$
$V_{IL}$	Logic "0" input voltage	—	—	0.8		
$I_{IN+}$	Input bias current (HO = High)	—	5	20	$\mu A$	$V_{IN} = 5V$
$I_{IN-}$	Input bias current (HO = Low)	—	—	2		$V_{IN} = 0V$

## Dynamic Electrical Characteristics

$V_{CC} = V_B = 15V$ ,  $V_S = COM$ ,  $T_A = 25^\circ C$ , and  $C_L = 1000pF$  unless otherwise specified.

Symbol	Definition	Min.	Typ.	Max.	Units	Test Conditions
$t_{ON}$	Turn-on propagation delay	—	220	300	ns	$V_S = 0V$
$t_{OFF}$	Turn-off propagation delay	—	200	280		$V_S = 0V$ or $700V$
$t_R$	Turn-on rise time	—	150	220		$V_S = 0V$
$t_F$	Turn-off fall time	—	50	80		
MT	Delay matching time ( $t_{ON}$ , $t_{OFF}$ )	—	0	50		

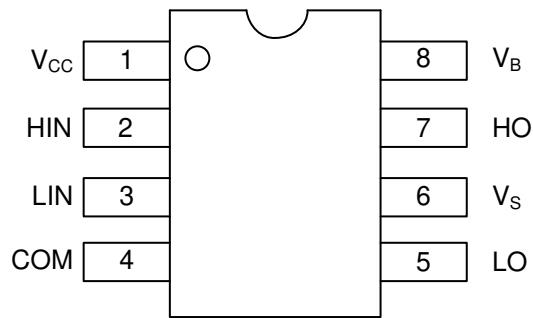
## Functional Block Diagram



## Lead Definitions

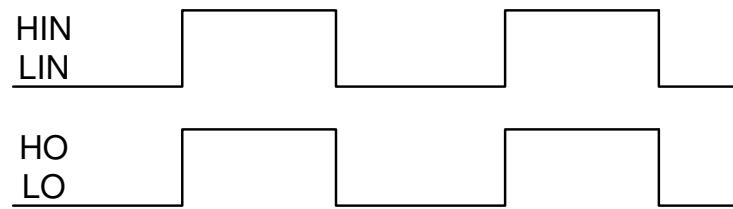
Symbol	Description
VCC	Low-side and logic supply voltage
VB	High-side gate drive floating supply
VS	High voltage floating supply return
HIN	Logic inputs for high-side gate driver output
LIN	Logic inputs for low-side gate driver output
HO	High-side driver output
LO	Low-side driver output
COM	Low-side gate drive return

## Lead Assignments

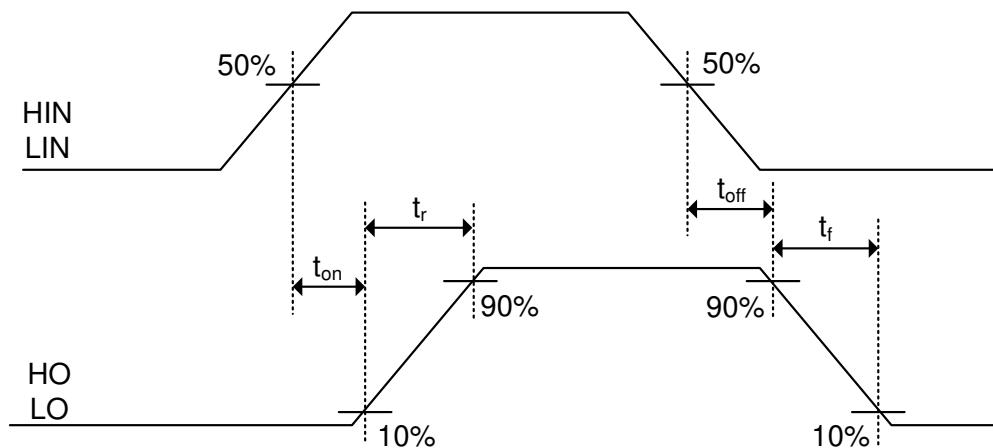


8-Lead SOIC

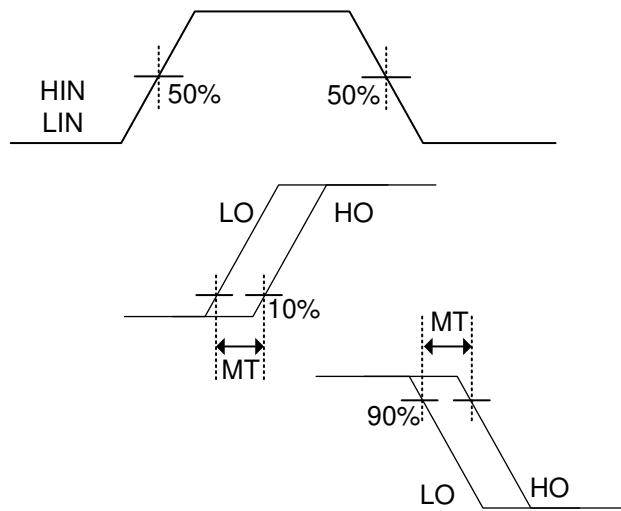
## Application Information and Additional Details



**Figure 1. Input/Output Timing Diagrams**

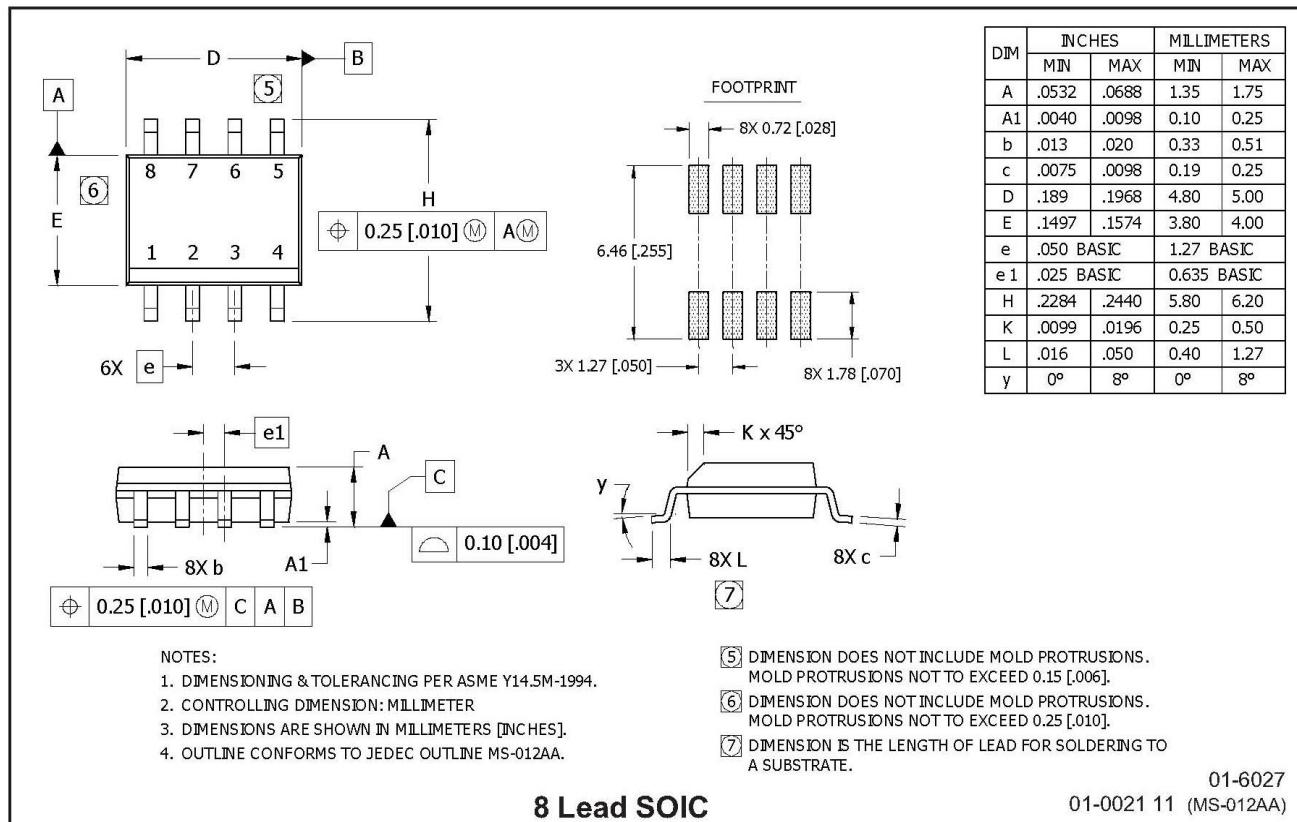


**Figure 2. Switching Time Waveform Definitions**

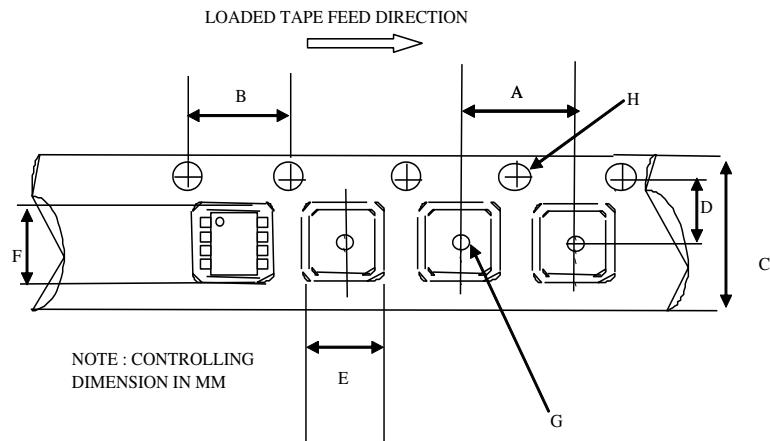


**Figure 3. Delay Matching Waveform Definitions**

## Package Details

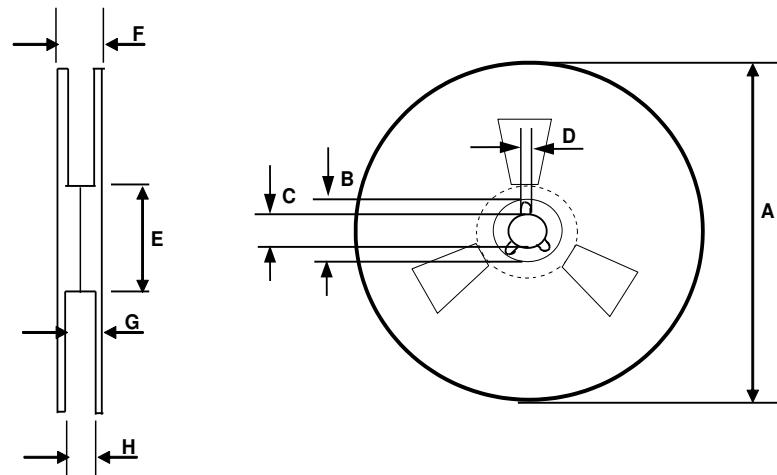


## Tape and Reel Details



CARRIER TAPE DIMENSION FOR 8SOICN

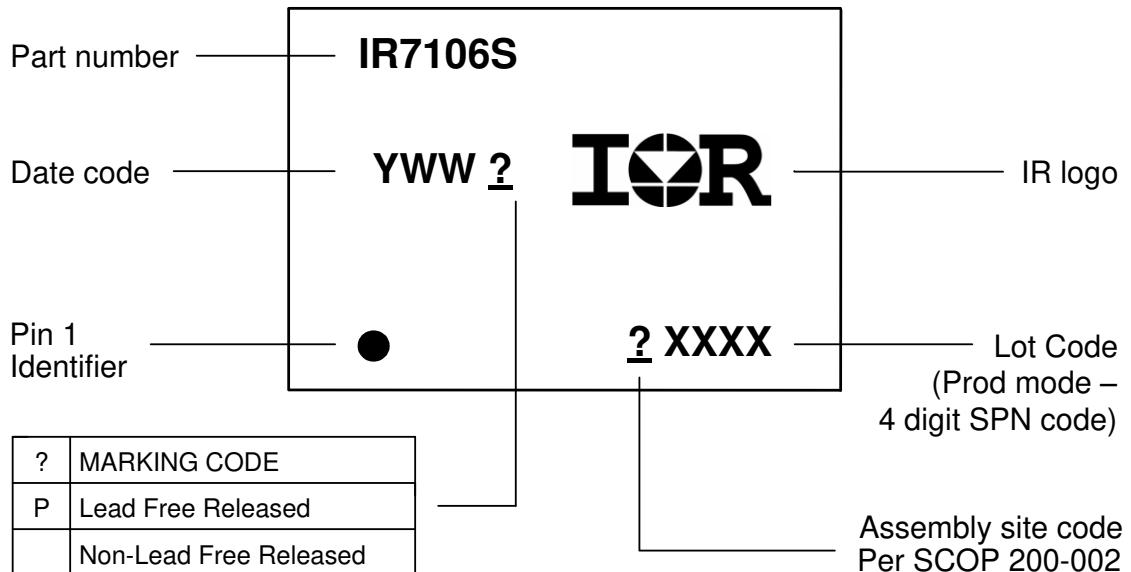
Code	Metric		Imperial	
	Min	Max	Min	Max
A	7.90	8.10	0.311	0.318
B	3.90	4.10	0.153	0.161
C	11.70	12.30	0.46	0.484
D	5.45	5.55	0.214	0.218
E	6.30	6.50	0.248	0.255
F	5.10	5.30	0.200	0.208
G	1.50	n/a	0.059	n/a
H	1.50	1.60	0.059	0.062



REEL DIMENSIONS FOR 8SOICN

Code	Metric		Imperial	
	Min	Max	Min	Max
A	329.60	330.25	12.976	13.001
B	20.95	21.45	0.824	0.844
C	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	18.40	n/a	0.724
G	14.50	17.10	0.570	0.673
H	12.40	14.40	0.488	0.566

## Part Marking Information



**Qualification Information<sup>†</sup>**

<b>Qualification Level</b>		Industrial <sup>††</sup>	
		Comments: This family of ICs has passed JEDEC's Industrial qualification. IR's Consumer qualification level is granted by extension of the higher Industrial level.	
<b>Moisture Sensitivity Level</b>		8 Lead SOIC	MSL2 <sup>†††</sup> , 260°C (per IPC/JEDEC J-STD-020)
<b>ESD</b>	Human Body Model	Class 1C (per JEDEC standard JEDEC JS-001-2012)	
	Machine Model	Class A (per EIA/JEDEC standard EIA/JESD22-A115)	
<b>IC Latch-Up Test</b>		Class I, Level A (per JESD78)	
<b>RoHS Compliant</b>		Yes	

<sup>†</sup> Qualification standards can be found at International Rectifier's web site <http://www.irf.com/>

<sup>††</sup> Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information.

<sup>†††</sup> Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.